# **Tyrone Camarero Specifications**

# **Tyrone**

#### Camarero IDI100A2T-22

#### **Key features**

Two hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Two 3rd Generation Intel Xeon Scalable processors up to 270W TDP
- Intel® C621A
- DDR4 3200 MT/s 16x DIMMS, 8x Intel Optane persistent memory per module; supports 8 GB to 128 GB DIMM options; number and capacity configurable
- 3 x16 PCIe 4.0, low-profile slots and 1 x8 PCIe 4.0 low-profile Slots
- 2x M.2 SATA/NVMe SSDs 80 or 110 mm and 2x U.2 NVMe hot-swap SSDs
- Integrated 10Gbase-T RJ45, VGA, Serial, and 2 USB 2.0 port connectivity
- M.2 and U.2 storage options
- 3x hot-swap CRPS 1600W (Titanium)
- 2U Rackmountable





#### Processor/Cache

Processor

Two 3rd Generation Intel Xeon Scalable processors up to 270W TDP

#### Chipset

Chipset

Intel® C621A

#### System Memory

**Memory Capacity** 

DDR4 3200 MT/s 16x DIMMS, 8x Intel Optane persistent memory per module; supports 8 GB to 128 GB DIMM options; number and capacity configurable

#### **Expansion Slots**

**PCI-Express** 

3 x16 PCIe 4.0, low-profile slots and 1 x8 PCIe 4.0 low-profile Slots

#### **Integrated Onboard**

LAN

Integrated 10Gbase-T RJ45, VGA, serial

USB

2 USB 2.0 port connectivity

## **Add-on Options**

Raid Card:

None

Optical Drive:

None

## **Drive Bays**

**HDD Bays** 

2x M.2 SATA/NVMe SSDs 80 or 110 mm and

2x U.2 NVMe hot-swap SSDs

#### **Power Supply**

3x hot-swap CRPS 1600W (Titanium)

#### **Form Factor**

Form Factor

2U Rackmount

Dimensions

16.93"" x 36.61"" x 3.44"

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For more/current product information, visit
www.tyronesystems.com

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